## UNITED STATES PATENT AND TRADEMARK OFFICE

Examiner:		Group:	Attorney Docket # 3750
	Applicant(s)	: HAHN, W., E	ΓAL
	Serial No.:	10/584,897	
	Filed:	06/28/2006	
	For:	MAGNETIC P	OLE FOR MAGNETIC
	INFORMAT	ION DISCLOS	URE STATEMENT
Honorable Com Patents and Trac Washington, D.	demarks	Jı	uly 20, 2009
SIRS:			
	gn Search Report		, Applicant(s) submit(s) herewith application and copies of the
	ent that the Foreig of is herewith sub	-	is in a foreign language, a
X Attached	hereto is a FORM	A PTO 1449 listi	ng the references.
application as fi documents and j acceptable State	led. The specifica pursuant to M.P.E	tion itself recites E.P. Section 609 ey. The reference	ed in the specification of the sthe relevance of these A (3) this represents an e(s) appear(s) at the following
Statement since fee is submitted	it is being submit herewith. Autho	ted after receipt rization is hereby	Information Disclosure of an office action. The required y given to debit the account of therewith: 19-4675.

Attached hereto are copies (except for US patents and/or publications) of references cited which may be pertinent to this application. Since the references are in the English language, no statement of relevancy is submitted.
Attached hereto is a copy of the Office Action issued in the corresponding German and European applications, together with a translation thereof and copies of the references cited therein. A list of the cited references is also attached.
Attached hereto copies of references cited which may be pertinent to this application. An English translation of the reference is also attached.
Attached hereto is a Statement of Relevancy and copies of references cited therein.
X Relevancy is indicated in an English language abstract or an English language equivalent attached hereto.
The Prior Art has been submitted in the parent application. A form PTO 1449 is being submitted herewith so that the cited art will be printed on the face of any patent issuing on this application.

Respectfully submitted,

Michael J. Striker Attorney for Applicant(s) Reg. No. 27233